- **Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs**
- **Dependable Texas Instruments Quality and Reliability**

## description

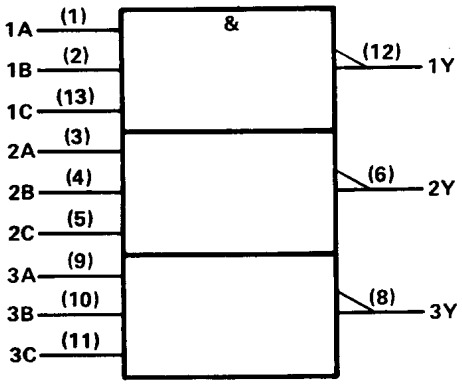
These devices contain three independent 3-input NAND gates.

The SN5410, SN54LS10, and SN54S10 are characterized for operation over the full military temperature range of −55°C to 125°C. The SN7410, SN74LS10, and SN74S10 are characterized for operation from 0°C to 70°C.

**FUNCTION TABLE (each gate)**

| INPUTS | | | OUTPUT |
|---|---|---|---|
| A | B | C | Y |
| H | H | H | L |
| L | X | X | H |
| X | L | X | H |
| X | X | L | H |

## logic symbol†

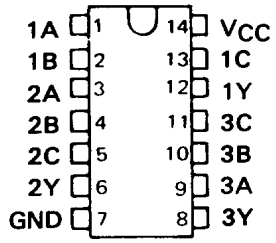



†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, and N packages.

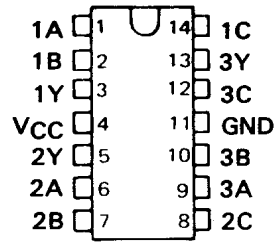
## positive logic

$$Y = \overline{A \cdot B \cdot C} \text{ or } Y = \overline{A} + \overline{B} + \overline{C}$$

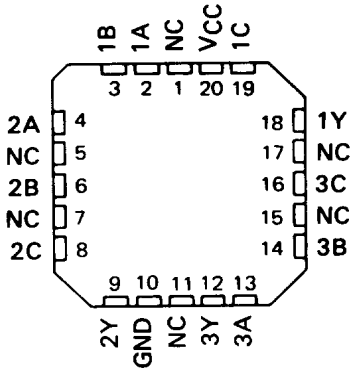
**SN5410 . . . J PACKAGE**
**SN54LS10, SN54S10 . . . J OR W PACKAGE**
**SN7410 . . . N PACKAGE**
**SN74LS10, SN74S10 . . . D OR N PACKAGE**
**(TOP VIEW)**




**SN5410 . . . W PACKAGE**
**(TOP VIEW)**

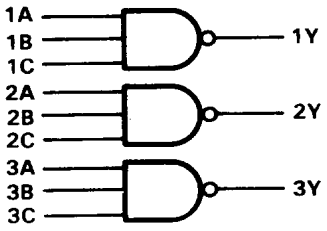



**SN54LS10, SN54S10 . . . FK PACKAGE**
**(TOP VIEW)**




NC - No internal connection

## logic diagram (positive logic)

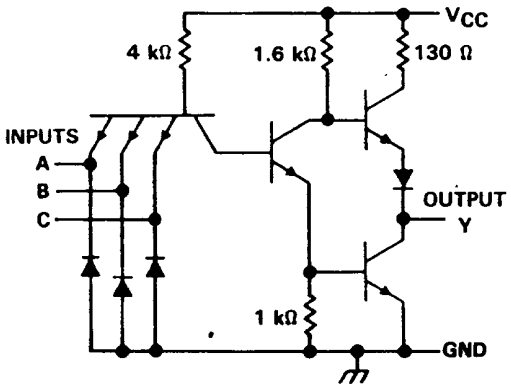



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

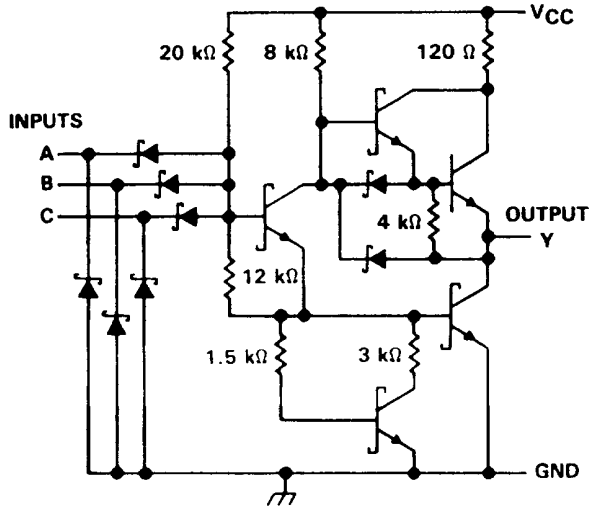
Copyright © 2003, Texas Instruments Incorporated

**schematics (each gate)**

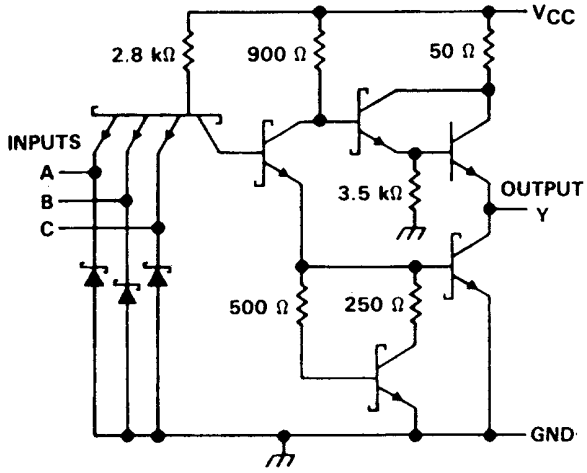
'10




'LS10




'S10




Resistor values shown are nominal.

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

Supply voltage, $V_{CC}$ (see Note 1) . . . . . 7 V
Input voltage: '10, 'S10 . . . . . 5.5 V
'LS10 . . . . . 7 V
Operating free-air temperature range: SN54' . . . . . −55°C to 125°C
SN74' . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

## recommended operating conditions

| | | SN5410 | | | SN7410 | | | UNIT |
|---|---|---|---|---|---|---|---|---|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| $V_{CC}$ | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| $V_{IH}$ | High-level input voltage | 2 | | | 2 | | | V |
| $V_{IL}$ | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| $I_{OH}$ | High-level output current | | | −0.4 | | | −0.4 | mA |
| $I_{OL}$ | Low-level output current | | | 16 | | | 16 | mA |
| $T_A$ | Operating free-air temperature | −55 | | 125 | 0 | | 70 | °C |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS † | SN5410 | | | SN7410 | | | UNIT |
|---|---|---|---|---|---|---|---|---|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| $V_{IK}$ | $V_{CC}$ = MIN, $I_I$ = −12 mA | | | −1.5 | | | −1.5 | V |
| $V_{OH}$ | $V_{CC}$ = MIN, $V_{IL}$ = 0.8 V, $I_{OH}$ = −0.4 mA | 2.4 | 3.4 | | 2.4 | 3.4 | | V |
| $V_{OL}$ | $V_{CC}$ = MIN, $V_{IH}$ = 2 V, $I_{OL}$ = 16 mA | | 0.2 | 0.4 | | 0.2 | 0.4 | V |
| $I_I$ | $V_{CC}$ = MAX, $V_I$ = 5.5 V | | | 1 | | | 1 | mA |
| $I_{IH}$ | $V_{CC}$ = MAX, $V_I$ = 2.4 V | | | 40 | | | 40 | μA |
| $I_{IL}$ | $V_{CC}$ = MAX, $V_I$ = 0.4 V | | | −1.6 | | | −1.6 | mA |
| $I_{OS}$§ | $V_{CC}$ = MAX | −20 | | −55 | −18 | | −55 | mA |
| $I_{CCH}$ | $V_{CC}$ = MAX, $V_I$ = 0 V | | 3 | 6 | | 3 | 6 | mA |
| $I_{CCL}$ | $V_{CC}$ = MAX, $V_I$ = 4.5 V | | 9 | 16.5 | | 9 | 16.5 | mA |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at $V_{CC}$ = 5 V, $T_A$ = 25°C.
§ Not more than one output should be shorted at a time.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C (see note 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|---|---|---|---|---|---|
| $t_{PLH}$ | A, B or C | Y | $R_L$ = 400 Ω, $C_L$ = 15 pF | | 11 | 22 | ns |
| $t_{PHL}$ | | | | | 7 | 15 | ns |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

## recommended operating conditions

| | SN54LS10 | | | SN74LS10 | | | UNIT |
|---|---|---|---|---|---|---|---|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| $V_{CC}$ Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| $V_{IH}$ High-level input voltage | 2 | | | 2 | | | V |
| $V_{IL}$ Low-level input voltage | | | 0.7 | | | 0.8 | V |
| $I_{OH}$ High-level output current | | | −0.4 | | | −0.4 | mA |
| $I_{OL}$ Low-level output current | | | 4 | | | 8 | mA |
| $T_A$ Operating free-air temperature | −55 | | 125 | 0 | | 70 | °C |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS † | | | SN54LS10 | | | SN74LS10 | | | UNIT |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| $V_{IK}$ | $V_{CC}$ = MIN, | $I_I$ = −18 mA | | | | −1.5 | | | −1.5 | V |
| $V_{OH}$ | $V_{CC}$ = MIN, | $V_{IL}$ = MAX, | $I_{OH}$ = −0.4 mA | 2.5 | 3.4 | | 2.7 | 3.4 | | V |
| $V_{OL}$ | $V_{CC}$ = MIN, | $V_{IH}$ = 2 V, | $I_{OL}$ = 4 mA | | 0.25 | 0.4 | | | 0.4 | V |
| | $V_{CC}$ = MIN, | $V_{IH}$ = 2 V, | $I_{OL}$ = 8 mA | | | | | 0.25 | 0.5 | |
| $I_I$ | $V_{CC}$ = MAX, | $V_I$ = 7 V | | | | 0.1 | | | 0.1 | mA |
| $I_{IH}$ | $V_{CC}$ = MAX, | $V_I$ = 2.7 V | | | | 20 | | | 20 | μA |
| $I_{IL}$ | $V_{CC}$ = MAX, | $V_I$ = 0.4 V | | | | −0.4 | | | −0.4 | mA |
| $I_{OS}$§ | $V_{CC}$ = MAX | | | −20 | | −100 | −20 | | −100 | mA |
| $I_{CCH}$ | $V_{CC}$ = MAX, | $V_I$ = 0 V | | | 0.6 | 1.2 | | 0.6 | 1.2 | mA |
| $I_{CCL}$ | $V_{CC}$ = MAX, | $V_I$ = 4.5 V | | | 1.8 | 3.3 | | 1.8 | 3.3 | mA |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at $V_{CC}$ = 5 V, $T_A$ = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C (see note 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|---|---|---|---|---|---|---|---|---|
| $t_{PLH}$ | A, B or C | Y | $R_L$ = 2 kΩ, | $C_L$ = 15 pF | | 9 | 15 | ns |
| $t_{PHL}$ | | | | | | 10 | 15 | ns |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

## recommended operating conditions

| | | SN54S10 | | | SN74S10 | | | UNIT |
|---|---|---|---|---|---|---|---|---|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| $V_{CC}$ | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| $V_{IH}$ | High-level input voltage | 2 | | | 2 | | | V |
| $V_{IL}$ | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| $I_{OH}$ | High-level output current | | | −1 | | | −1 | mA |
| $I_{OL}$ | Low-level output current | | | 20 | | | 20 | mA |
| $T_A$ | Operating free-air temperature | −55 | | 125 | 0 | | 70 | °C |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS † | | | SN54S10 | | | SN74S10 | | | UNIT |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| $V_{IK}$ | $V_{CC}$ = MIN, | $I_I$ = −18 mA | | | | −1.2 | | | −1.2 | V |
| $V_{OH}$ | $V_{CC}$ = MIN, | $V_{IL}$ = 0.8 V, | $I_{OH}$ = −1 mA | 2.5 | 3.4 | | 2.7 | 3.4 | | V |
| $V_{OL}$ | $V_{CC}$ = MIN, | $V_{IH}$ = 2 V, | $I_{OL}$ = 20 mA | | | 0.5 | | | 0.5 | V |
| $I_I$ | $V_{CC}$ = MAX, | $V_I$ = 5.5 V | | | | 1 | | | 1 | mA |
| $I_{IH}$ | $V_{CC}$ = MAX, | $V_I$ = 2.7 V | | | | 50 | | | 50 | μA |
| $I_{IL}$ | $V_{CC}$ = MAX, | $V_I$ = 0.5 V | | | | −2 | | | −2 | mA |
| $I_{OS}$§ | $V_{CC}$ = MAX | | | −40 | | −100 | −40 | | −100 | mA |
| $I_{CCH}$ | $V_{CC}$ = MAX, | $V_I$ = 0 V | | | 7.5 | 12 | | 7.5 | 12 | mA |
| $I_{CCL}$ | $V_{CC}$ = MAX, | $V_I$ = 4.5 V | | | 15 | 27 | | 15 | 27 | mA |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at $V_{CC}$ = 5 V, $T_A$ = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C (see note 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|---|---|---|---|---|---|---|---|---|
| $t_{PLH}$ | A, B or C | Y | $R_L$ = 280 Ω, | $C_L$ = 15 pF | | 3 | 4.5 | ns |
| $t_{PHL}$ | | | | | | 3 | 5 | ns |
| $t_{PLH}$ | | | $R_L$ = 280 Ω, | $C_L$ = 50 pF | | 4.5 | | ns |
| $t_{PHL}$ | | | | | | 5 | | ns |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

## PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|---|---|---|---|---|---|---|---|---|---|---|---|
| JM38510/07005BCA | ACTIVE | CDIP | J | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07005BCA | Samples |
| JM38510/07005BDA | ACTIVE | CFP | W | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07005BDA | Samples |
| JM38510/30005B2A | ACTIVE | LCCC | FK | 20 | 55 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30005B2A | Samples |
| JM38510/30005BCA | ACTIVE | CDIP | J | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30005BCA | Samples |
| JM38510/30005BDA | ACTIVE | CFP | W | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30005BDA | Samples |
| JM38510/30005SDA | ACTIVE | CFP | W | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30005SDA | Samples |
| M38510/07005BCA | ACTIVE | CDIP | J | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07005BCA | Samples |
| M38510/07005BDA | ACTIVE | CFP | W | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07005BDA | Samples |
| M38510/30005B2A | ACTIVE | LCCC | FK | 20 | 55 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30005B2A | Samples |
| M38510/30005BCA | ACTIVE | CDIP | J | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30005BCA | Samples |
| M38510/30005BDA | ACTIVE | CFP | W | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30005BDA | Samples |
| M38510/30005SDA | ACTIVE | CFP | W | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30005SDA | Samples |
| SN54LS10J | ACTIVE | CDIP | J | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS10J | Samples |
| SN54S10J | ACTIVE | CDIP | J | 14 | 25 | Non-RoHS & Non-Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54S10J | Samples |
| SN74LS10D | LIFEBUY | SOIC | D | 14 | 50 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS10 | |
| SN74LS10DR | ACTIVE | SOIC | D | 14 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS10 | Samples |
| SN74LS10DRG4 | ACTIVE | SOIC | D | 14 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS10 | Samples |

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|---|---|---|---|---|---|---|---|---|---|---|---|
| SN74LS10N | ACTIVE | PDIP | N | 14 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS10N | Samples |
| SN74LS10NSR | ACTIVE | SO | NS | 14 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS10 | Samples |
| SN74S10N | ACTIVE | PDIP | N | 14 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74S10N | Samples |
| SNJ54LS10FK | ACTIVE | LCCC | FK | 20 | 55 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54LS 10FK | Samples |
| SNJ54LS10J | ACTIVE | CDIP | J | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54LS10J | Samples |
| SNJ54LS10W | ACTIVE | CFP | W | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54LS10W | Samples |
| SNJ54S10J | ACTIVE | CDIP | J | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54S10J | Samples |
| SNJ54S10W | ACTIVE | CFP | W | 14 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54S10W | Samples |

(1) The marketing status values are defined as follows:
**ACTIVE:** Product device recommended for new designs.
**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.
**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54LS10, SN54LS10-SP, SN54S10, SN74LS10, SN74S10 :**

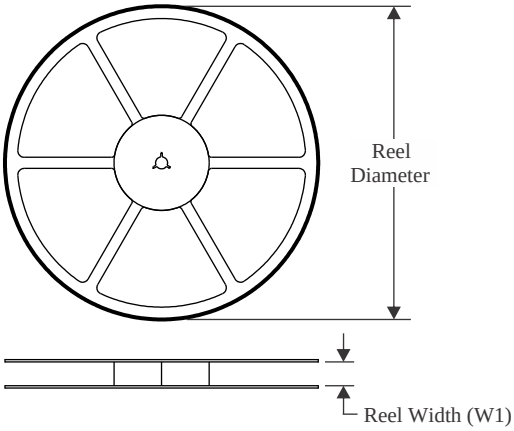
- Catalog : SN74LS10, SN54LS10, SN74S10
- Military : SN54LS10, SN54S10
- Space : SN54LS10-SP

NOTE: Qualified Version Definitions:

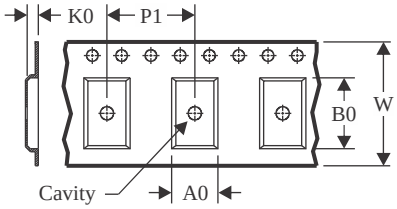
- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

## TAPE AND REEL INFORMATION

**REEL DIMENSIONS**

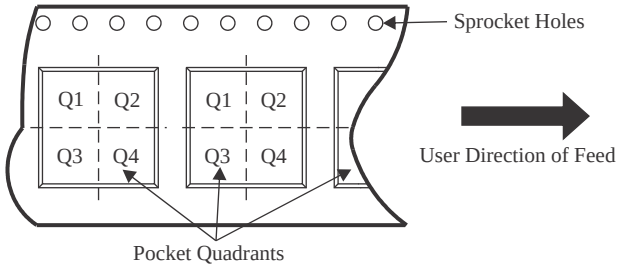



**TAPE DIMENSIONS**




| | |
|---|---|
| A0 | Dimension designed to accommodate the component width |
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

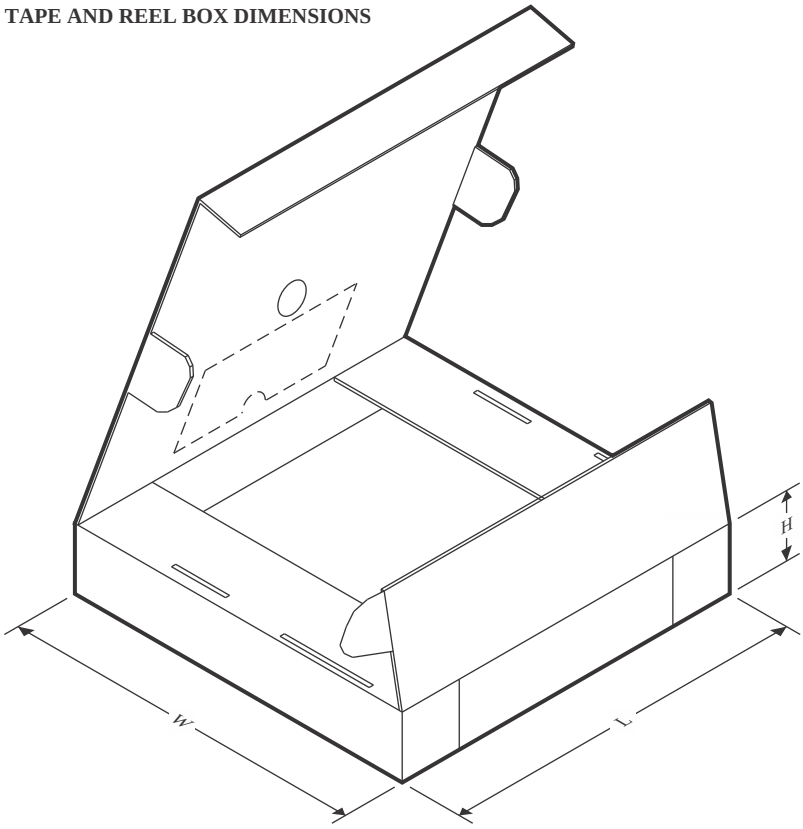
**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**




*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| SN74LS10DR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LS10NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |

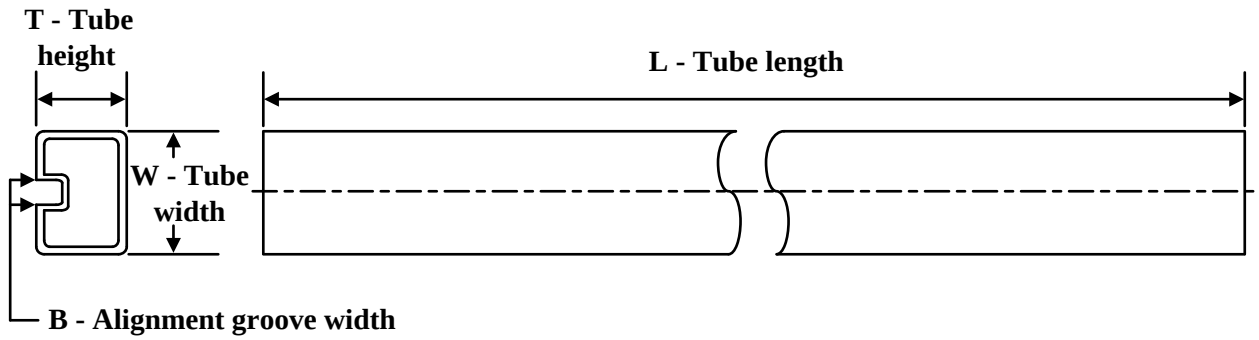
TAPE AND REEL BOX DIMENSIONS




*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---|---|---|---|---|---|---|---|
| SN74LS10DR | SOIC | D | 14 | 2500 | 356.0 | 356.0 | 35.0 |
| SN74LS10NSR | SO | NS | 14 | 2000 | 356.0 | 356.0 | 35.0 |

## TUBE



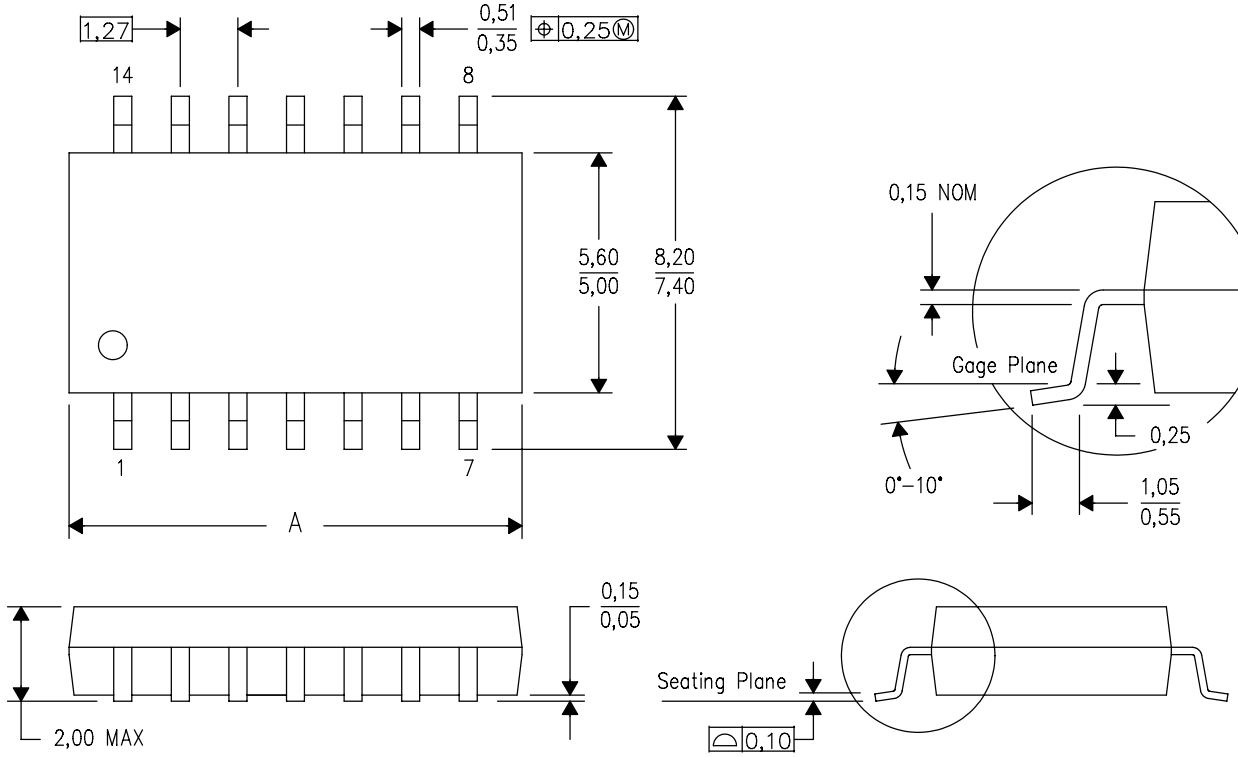

*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|---|---|---|---|---|---|---|---|---|
| JM38510/07005BDA | W | CFP | 14 | 25 | 506.98 | 26.16 | 6220 | NA |
| JM38510/30005B2A | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| JM38510/30005BDA | W | CFP | 14 | 25 | 506.98 | 26.16 | 6220 | NA |
| JM38510/30005SDA | W | CFP | 14 | 25 | 506.98 | 26.16 | 6220 | NA |
| M38510/07005BDA | W | CFP | 14 | 25 | 506.98 | 26.16 | 6220 | NA |
| M38510/30005B2A | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| M38510/30005BDA | W | CFP | 14 | 25 | 506.98 | 26.16 | 6220 | NA |
| M38510/30005SDA | W | CFP | 14 | 25 | 506.98 | 26.16 | 6220 | NA |
| SN74LS10D | D | SOIC | 14 | 50 | 506.6 | 8 | 3940 | 4.32 |
| SN74LS10N | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS10N | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74S10N | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74S10N | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SNJ54LS10FK | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| SNJ54LS10W | W | CFP | 14 | 25 | 506.98 | 26.16 | 6220 | NA |

## MECHANICAL DATA

**NS (R-PDSO-G**)** **PLASTIC SMALL-OUTLINE PACKAGE**

**14-PINS SHOWN**

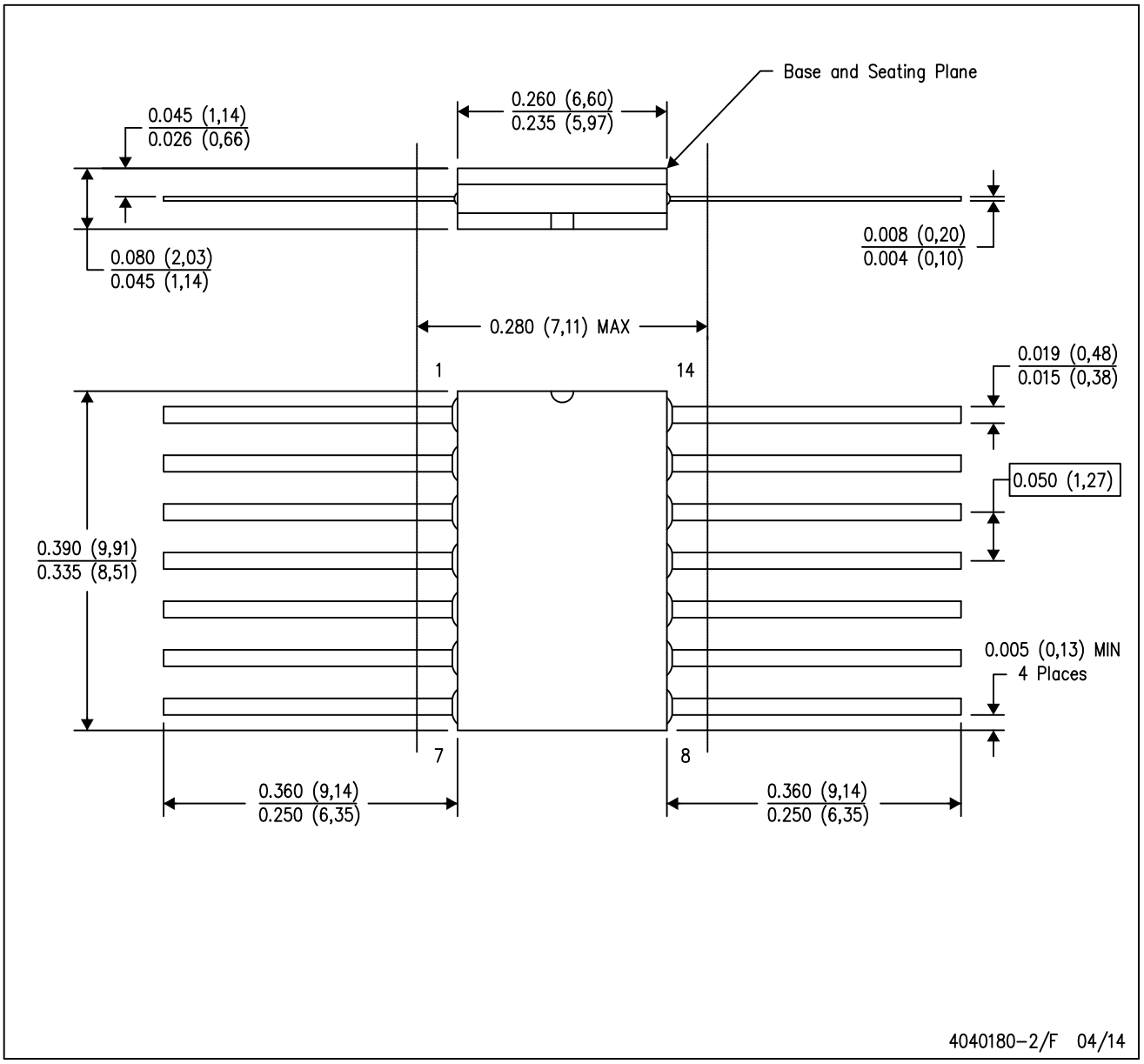



| DIM \ PINS ** | 14 | 16 | 20 | 24 |
|---|---|---|---|---|
| A MAX | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN | 9,90 | 9,90 | 12,30 | 14,70 |

4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

W (R–GDFP–F14) CERAMIC DUAL FLATPACK




NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F14

# GENERIC PACKAGE VIEW

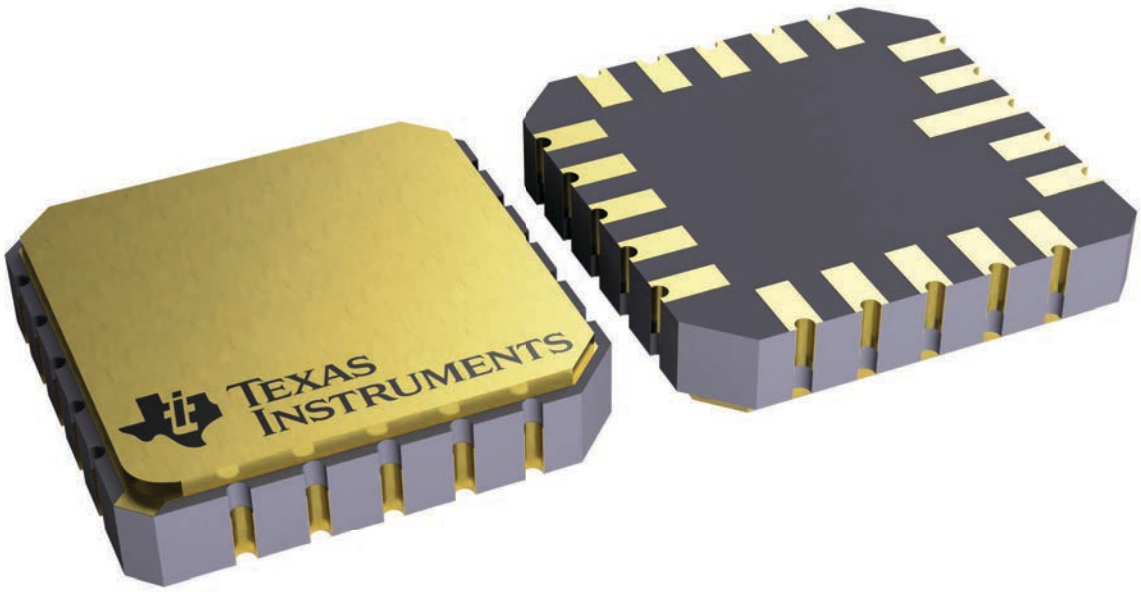
## FK 20

## LCCC - 2.03 mm max height

**8.89 x 8.89, 1.27 mm pitch**

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

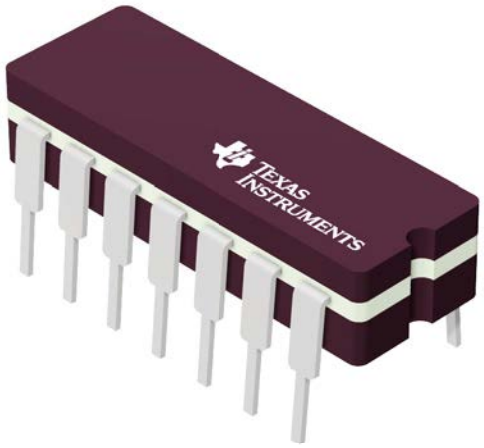



4229370VA\

# GENERIC PACKAGE VIEW

## J 14 CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE




Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4040083-5/G

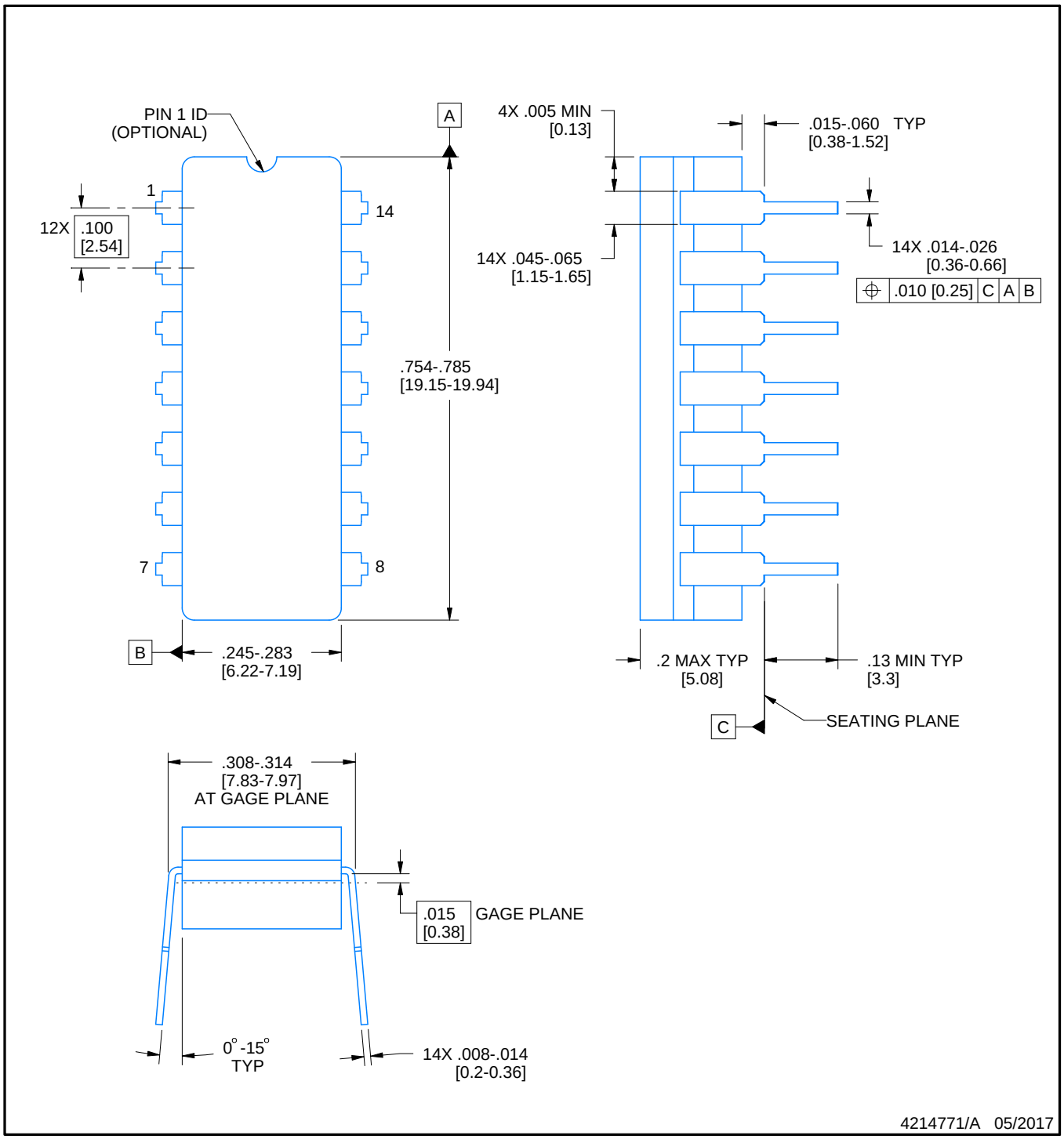


# PACKAGE OUTLINE

## J0014A

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE




NOTES:

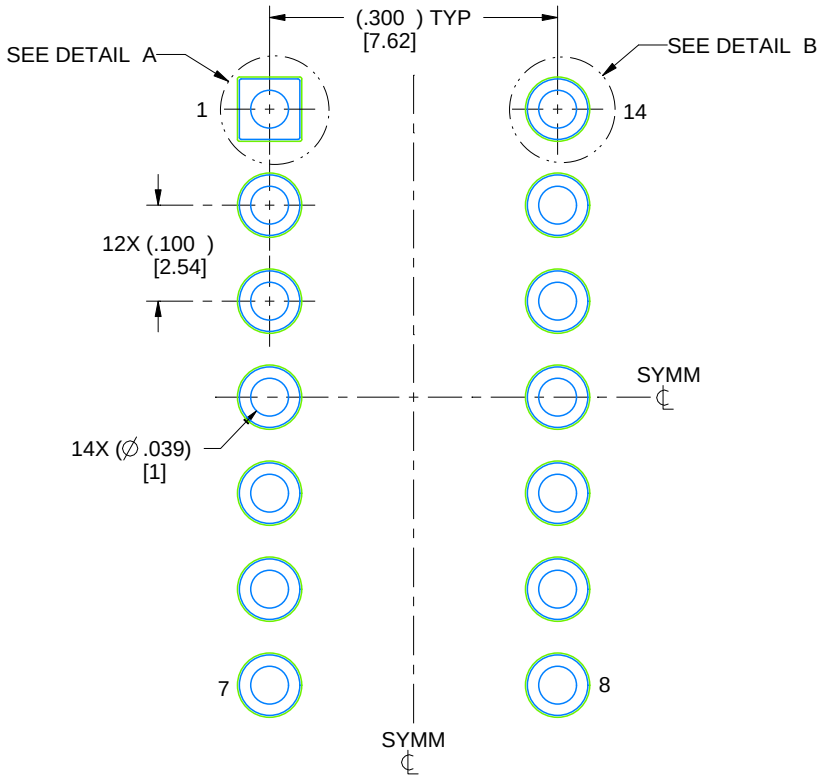
1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermitically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.

# EXAMPLE BOARD LAYOUT

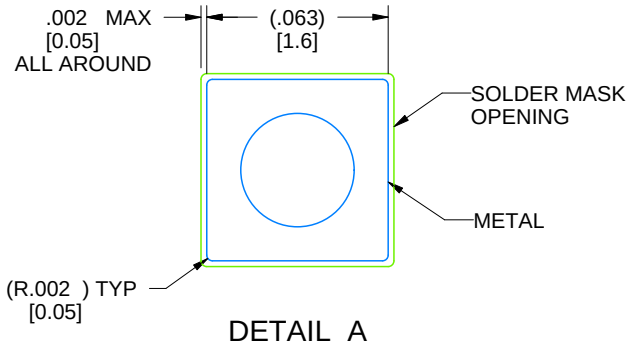
## J0014A

## CDIP - 5.08 mm max height

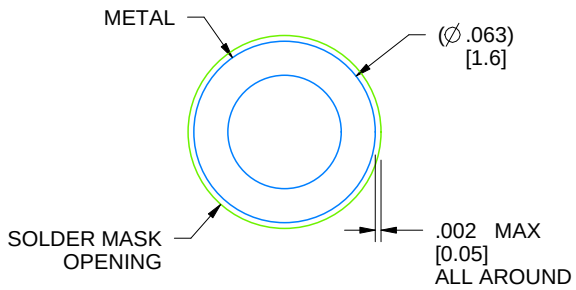
CERAMIC DUAL IN LINE PACKAGE




LAND PATTERN EXAMPLE
NON-SOLDER MASK DEFINED
SCALE: 5X



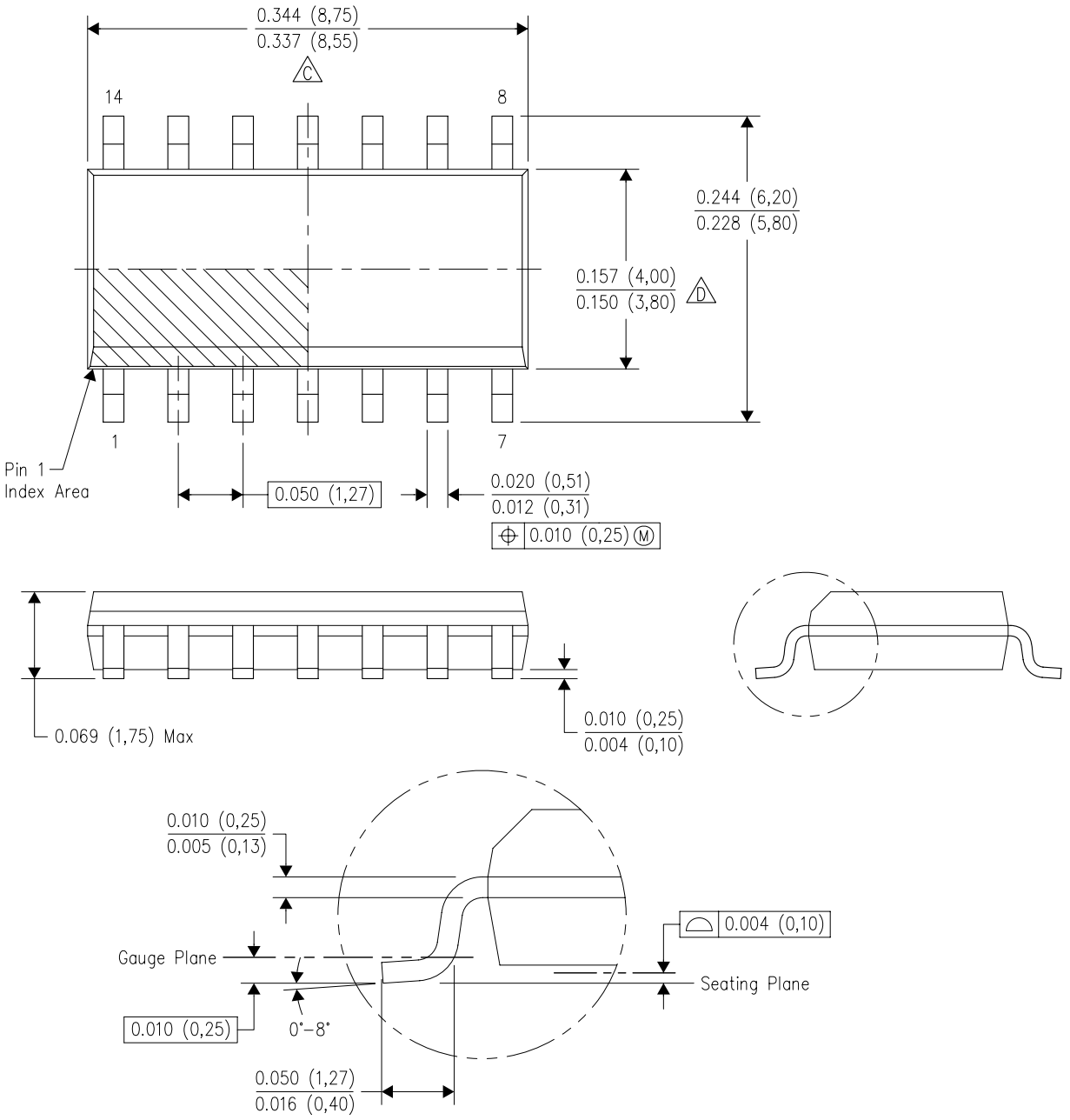

DETAIL A
SCALE: 15X




DETAIL B
13X, SCALE: 15X

4214771/A 05/2017

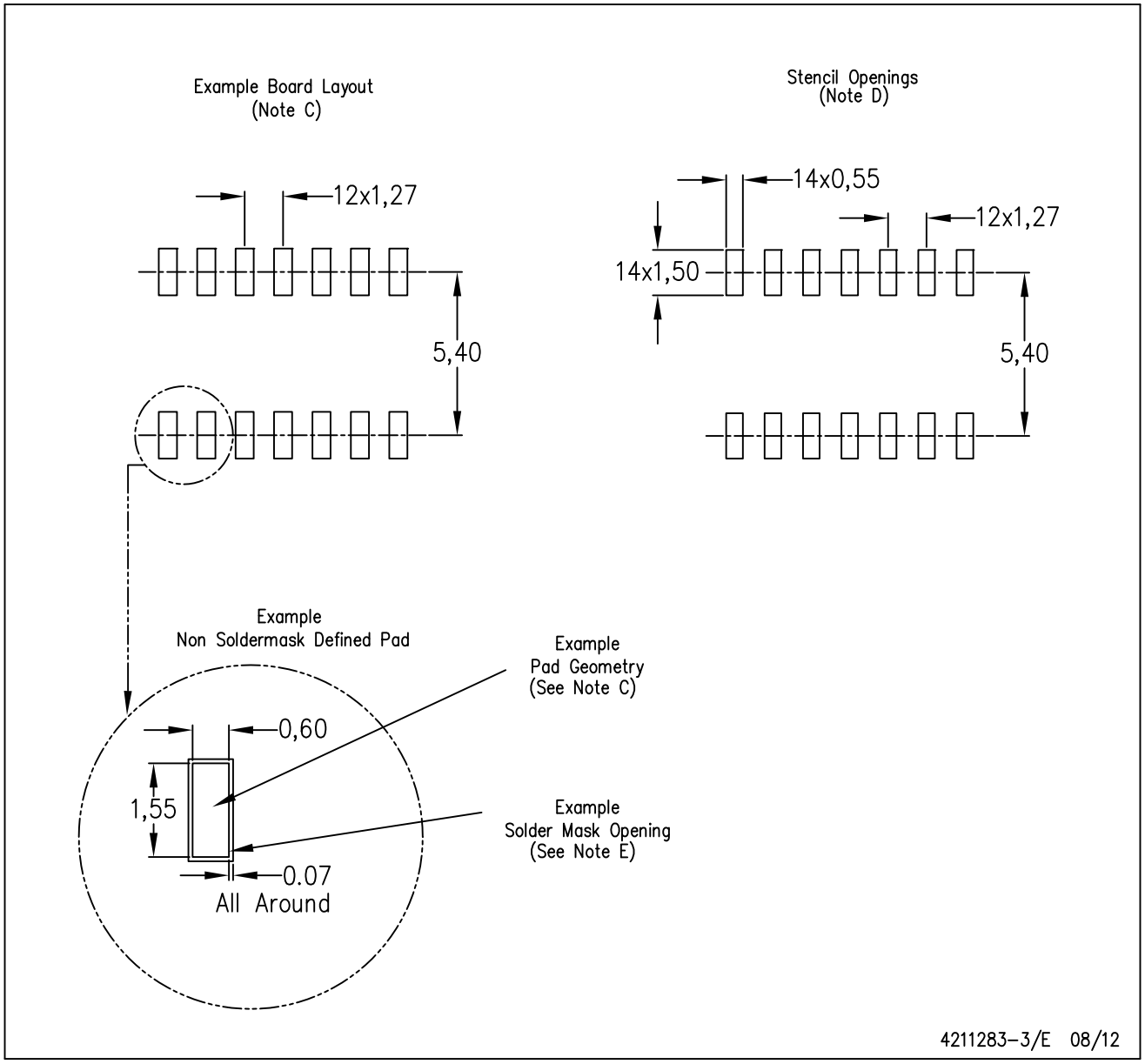
D (R–PDSO–G14) PLASTIC SMALL OUTLINE




4040047–5/M 06/11

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AB.

D (R–PDSO–G14) PLASTIC SMALL OUTLINE

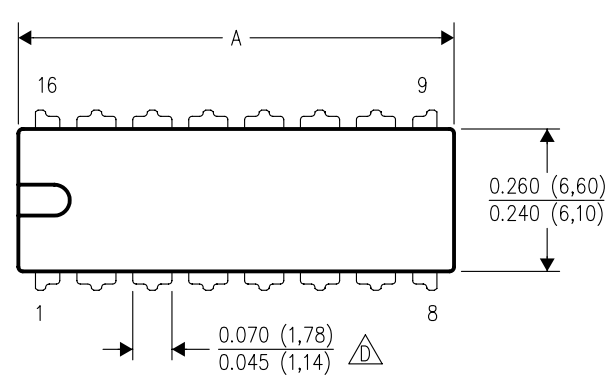



NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC–7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC–7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

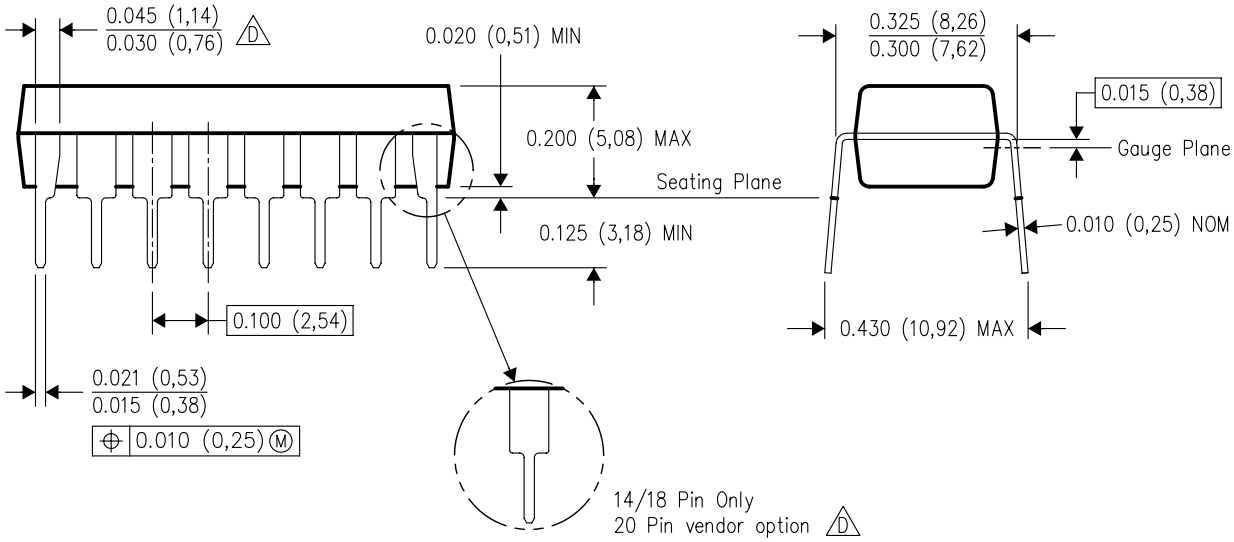
## N (R–PDIP–T**)

## PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN




| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---|---|---|---|---|
| A MAX | 0.775 (19,69) | 0.775 (19,69) | 0.920 (23,37) | 1.060 (26,92) |
| A MIN | 0.745 (18,92) | 0.745 (18,92) | 0.850 (21,59) | 0.940 (23,88) |
| MS–001 VARIATION (C) | AA | BB | AC | AD |




4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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